

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	IKB06N60T	**Issued**	02. June 2021
MA#	MA002874730		
Package	PG-TO263-3-2	**Weight***	1557.14 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip_1	inorganic material	silicon	7440-21-3	0.447	0.03	0.03	287	287
chip_2	inorganic material	silicon	7440-21-3	0.812	0.05	0.05	522	522
leadframe	inorganic material	phosphorus	7723-14-0	0.091	0.01		59	
	non noble metal	iron	7439-89-6	0.304	0.02		195	
	non noble metal	copper	7440-50-8	304.026	19.52	19.55	195246	195500
wire	non noble metal	aluminium	7429-90-5	1.944	0.12	0.12	1248	1248
encapsulation	inorganic material	zincoxide	1314-13-2	6.897	0.44		4429	
	miscellaneous	miscellaneous	-	27.587	1.77		17717	
	plastics	epoxy resin	-	103.452	6.64		66437	
	inorganic material	silicondioxide	60676-86-0	551.742	35.45	44.30	354329	442912
leadfinish	non noble metal	tin	7440-31-5	9.657	0.62	0.62	6202	6202
plating	inorganic material	phosphorus	7723-14-0	0.001			1	
	non noble metal	nickel	7440-02-0	0.228	0.01	0.01	147	148
solder	non noble metal	tin	7440-31-5	0.031			20	
	noble metal	silver	7440-22-4	0.039			25	
	non noble metal	lead	7439-92-1	1.502	0.10	0.10	965	1010
heatspreader	inorganic material	phosphorus	7723-14-0	0.165	0.01		106	
	non noble metal	iron	7439-89-6	0.548	0.04		352	
	non noble metal	copper	7440-50-8	547.666	35.17	35.22	351713	352171
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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